

(2,54 mm) .100"

HLE SERIES

COST-EFFECTIVE RELIABLE SOCKET

Mates With: TSW, MTSW, DW, EW, ZW, TLW, TSM, MTLW, HW

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?HLÉ

Insulator Material:

Black Liquid Crystal Polymer Contact Material:

Plating: Au or Sn over

50μ" (1,27 μm) Ni Current Rating (HLE/TSM):

4.1 A per pin (1 pin powered per row) Voltage Rating: 400 VAC

Operating Temp Range:

-55°C to +125°C Insertion Depth: (1,78 mm) .070" to (3,43 mm) .135", pass-through, or (2,59 mm) .102" min plus board thickness for bottom entry

Insertion Force: (Single contact only) 2 oz (0,56 N) avg.

Withdrawal Force: (Single contact only) 1.6 oz (0,44 N) avg. **RoHS Compliant:**

Processing:

Lead-Free Solderable:

SMT Lead Coplanarity:

(0,10 mm) .004" max (02-20) (0,15 mm) .006" max (21-50)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

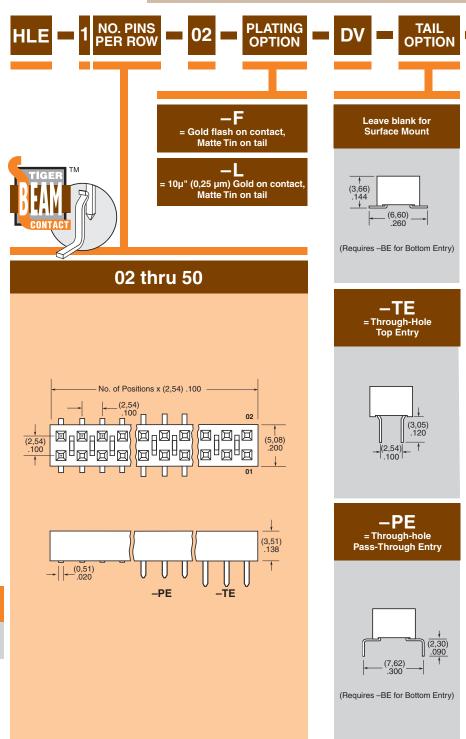




ALSO AVAILABLE (MOQ Required)

 Other platings Contact Samtec.

Note: Some lengths, styles and options are non-standard, non-returnable,



OPTION

-BE Bottom Entry

(N/A with -TE)

–А = Alignment Pin (4 positions min.) Metal or plastic at Samtec discretion (N/A with -TE, -PE & -LC)



-LC = Locking Clip (2 positions min.) (N/A with -A) (Manual placement required)



= (6,50 mm) .256' DIA Polyimide Film Pick & Place Pad (3 positions min.) Not available with -TE or

-PE tail option



(5,71) .225 (3,86) .152

= Tape & Reel Packaging (29 positions max.)

Due to technical progress, all designs, specifications and components are subject to change without notice.

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